

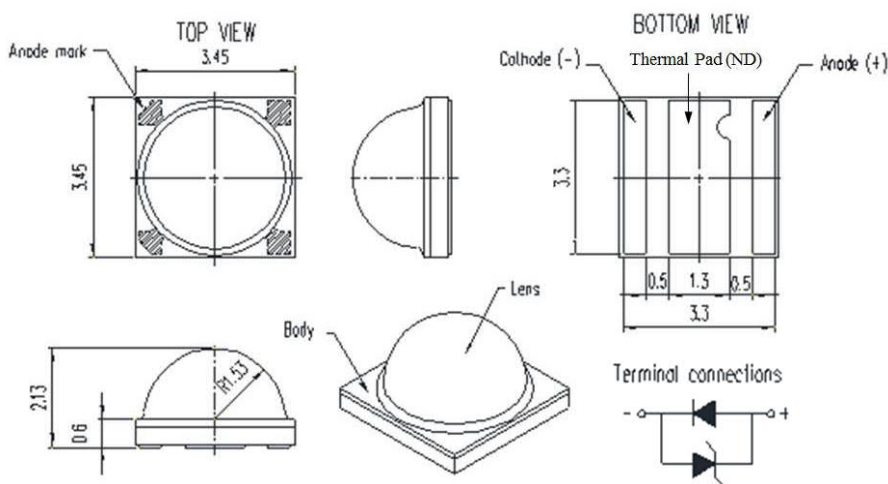
1. Description

The YL-3535D(130)-365nm(720mW) UV Product series is a revolutionary, energy efficient light source for UV curing and common UV application, combining the lifetime and reliability advantages of Light Emitting Diodes with the brightness of conventional light source. It gives you design freedom, and creating a new opportunities for solid state UV light source to displace conventional UV technologies

Features

- I.C. compatible
- RoHS compliant and Pb free
- Lower operating costs
- Reduced maintenance costs

2. Outline Dimensions



Item	Description
Package Materials	Ceramics
Encapsulating Resin Materials	Silicone Resin
Electrodes Materials	Au-plated

Notes :

1. All dimensions are in millimeters and dimension tolerances are $\pm 0.2\text{mm}$ except lens height and ceramic length / width dimension tolerance are $\pm 0.1\text{mm}$
2. Thermal pad of the device is electrically neutral from the anode and cathode pads

3. Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Unit
DC Forward Current	I_f	700	mA
Power Consumption	P_o	3.08	W
Operating Temp Range	T_{opr}	-40 ~ +85	°C
Storage Temp Range	T_{stg}	-55 ~ +100	°C
Junction Temperature	T_j	90	°C

Notes:

Operating the LED under reverse bias condition long time might result in damage or failure of the component.

4. Electro-Optical Characteristics at Ta=25°C

Parameter	Symbol	Values		Test Condition	Unit
Forward Voltage	V_f	Min.	2.8	If = 500mA	V
		Typ.	3.8		
		Max.	4.4		
Radiant Flux	Φ_e	Min.	560	If = 500mA	mW
		Typ.	720		
		Max	900		
Peak Wavelength	λ_p	Min.	360	If = 500mA	nm
		Max	370		
Viewing Angle	$2\theta_{1/2}$	Typ.	130	If = 500mA	°
Thermal Resistance	R_{thjc}	Typ	5.1	---	°C/W

Notes:

1. Radiant flux (Φ_e) is the total Radiant flux output as measured with an integrating sphere.
2. Thermal resistance (Junction to case) measurement tolerance is $\pm 10\%$

5. Bin Code List

Vf : Forward Voltage Spec. Table		
Vf Bin	Vf (V) @ If = 500mA	
	Min.	Max.
V0	2.8	3.2
V1	3.2	3.6
V2	3.6	4.0
V3	4.0	4.4

Forward Voltage Tolerance: +/- 0.1 V

Φ_e : Radiant Flux Spec. Table		
Φ_e Bin	Φ_e (mW) @ If = 500mA	
	Min.	Max.
GH	560	610
HI	610	665
IJ	665	720
JK	720	775
KL	775	835
MN	835	900

Radiant Flux Tolerance: +/- 10%

Wp: Peak Wavelength Spec table		
Wp Bin	Wp (nm) @ If = 500mA	
	Min.	Max.
P3M	360	365
P3N	365	370

Peak Wavelength Tolerance: +/- 3nm

Notes:

1. Bin classification code is marked on each packing bag.

6. Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

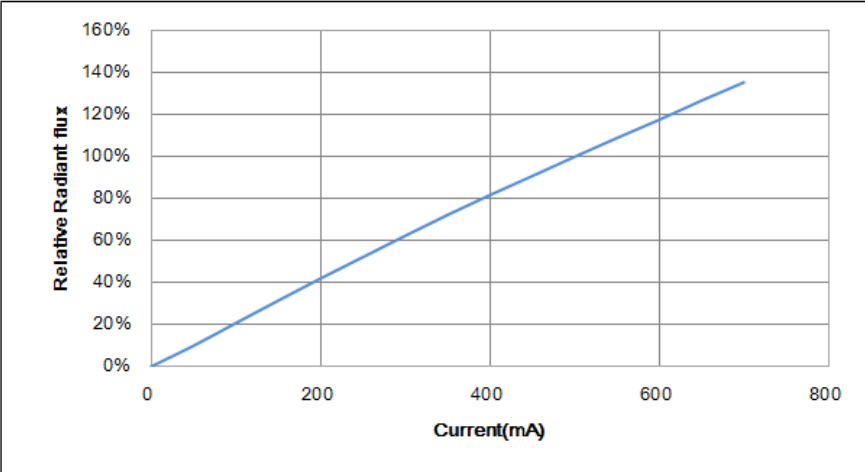


Fig 1. Relative Radiant Flux vs. Forward Current

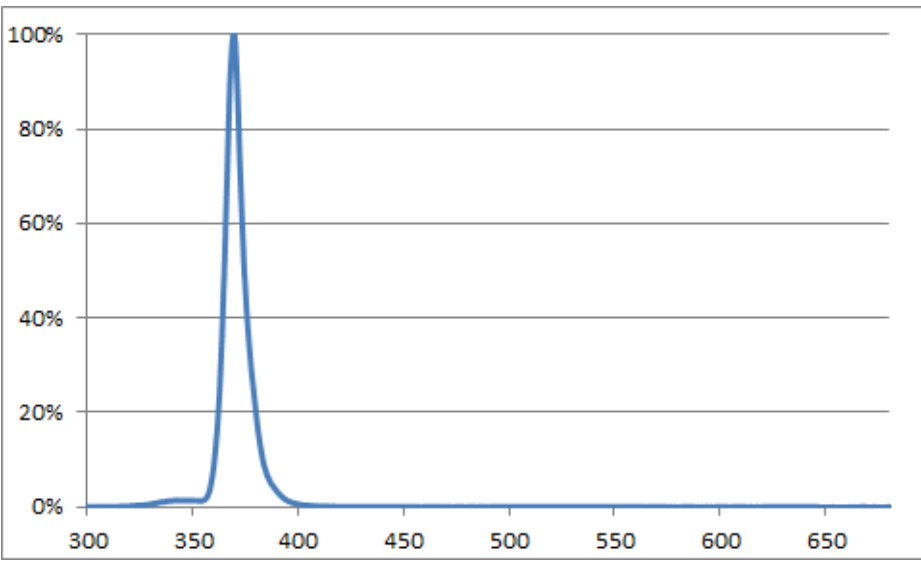


Fig 2. Relative Spectral Distribution

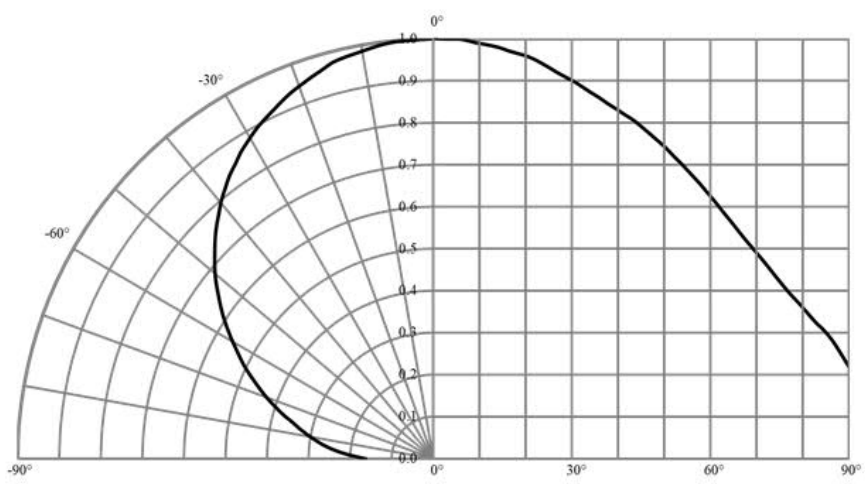


Fig 3. Radiation Characteristics

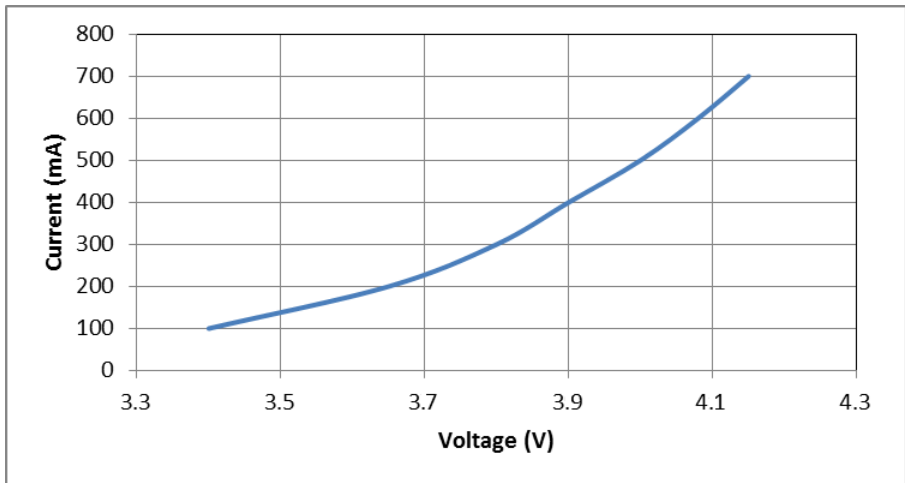


Fig 4. Forward Current vs. Forward Voltage

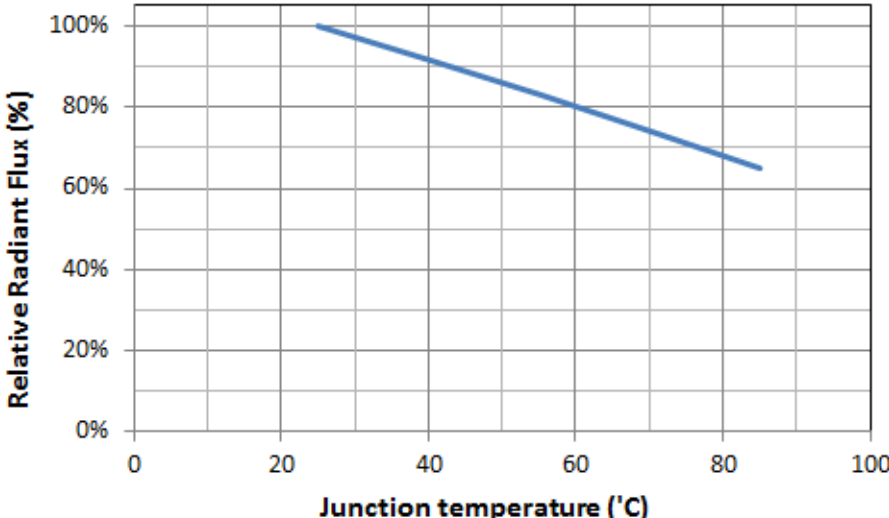


Fig.5 Relative Radiant Flux vs Junction Temperature

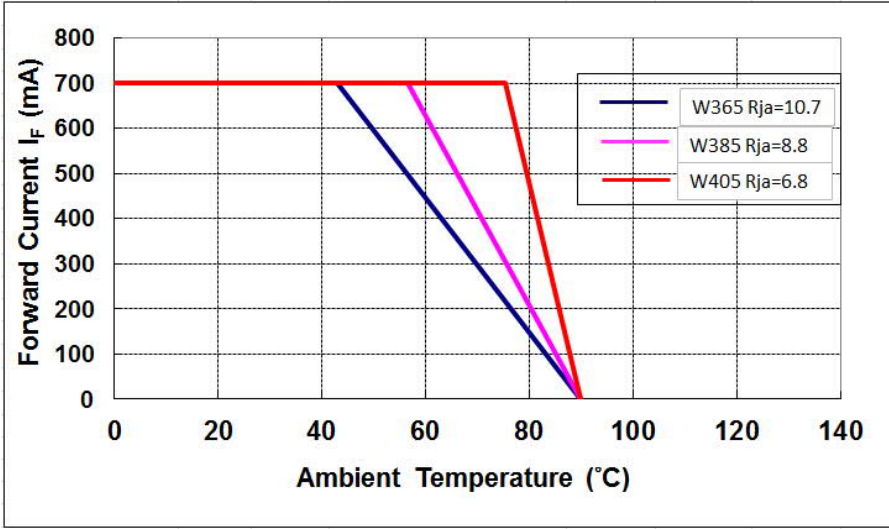


Fig 6. Forward Current Degrading Curve of YL-3535D(130) Series

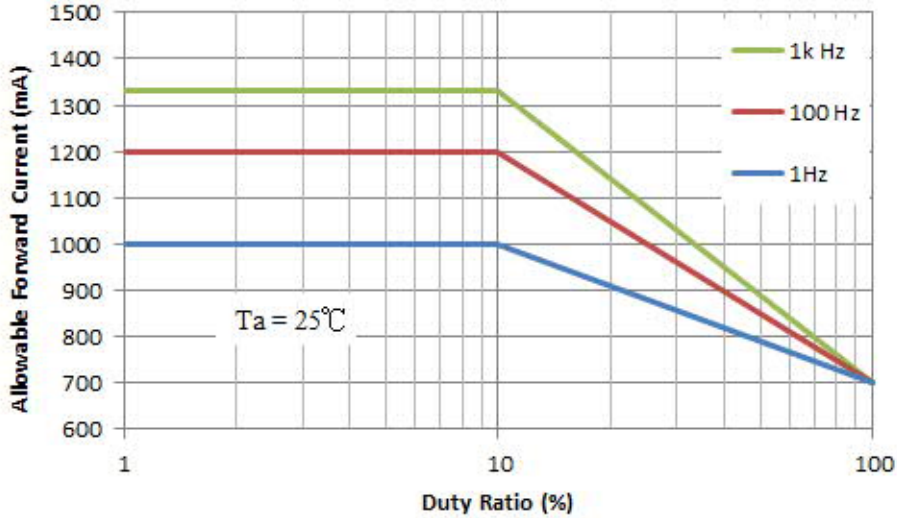


Fig.7 Allowable Forward Current vs Duty Ratio

7. Reliability Test Plan

No	Test item	Condition	Duration	Number of Failed
1	Low Temperature Operating Life (LTOL)	$T_c = -10^{\circ}\text{C}$, $I_f = 500\text{mA}$	1000 hrs	0/10
2	Room Temperature Operating Life (RTOL)	25°C , $I_f = 700\text{mA}$	1000 hrs	0/10
3	High Temperature Operating Life (HTOL)	$T_c = 85^{\circ}\text{C}$, $I_f = 60\text{mA}$	1000 hrs	0/10
4	Wet High Temperature Operating Life (WHTOL)	$60^{\circ}\text{C}/60\%\text{RH}$, $I_f = 350\text{mA}$	500 hrs	0/10
5	Non-Operating Thermal Shock (TMSK)	-40°C to 125°C 30 minutes dwell, <10 seconds transfer	100 cycles	0/10
6	Resistance to Soldering Heat (Reflow Soldering)	(Pre-store @ 25°C , $60\pm 5\%\text{RH}$ for 168hrs) TSlid = 260°C , 10 sec	2 times	0/10
7	Solderability Test	245°C , 5sec Pb free solder, wetting >95%	1 time	0/10

Notes:

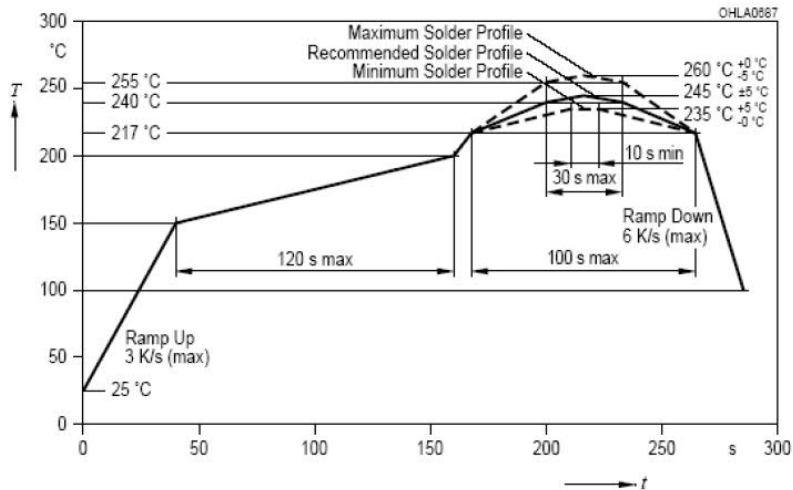
1. Operating life test are mounted on thermal heat sink

Criteria for Judging the Damage

Item	Symbol	Test Condition	Criteria for Judgment	
			Min.	Max.
Forward Voltage	V_f	$I_f = \text{Typical Current}$	-10%	+10%
Radiant Flux	Φ_e	$I_f = \text{Typical Current}$	-15%	+15%

8. User Guide

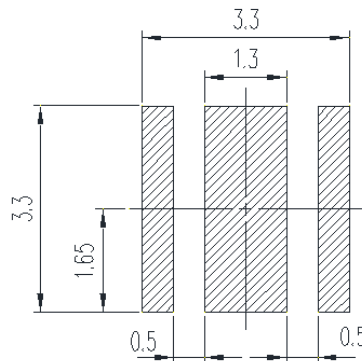
Suggested Reflow Soldering Characteristics



Notes:

1. All temperatures refer to topside of the package, measured on the package body surface.
2. The soldering profile could be further referred to different soldering grease material characteristic. The grease vendor will provide this information.
3. A rapid-rate process is not recommended for the LEDs cooling down from the peak temperature.
4. Although the recommended reflow conditions are specified above, the reflow or hand soldering condition at the lowest possible temperature is desirable for the LEDs.
5. YesLED cannot make a guarantee on the LEDs which have been already assembled using the dip soldering method.

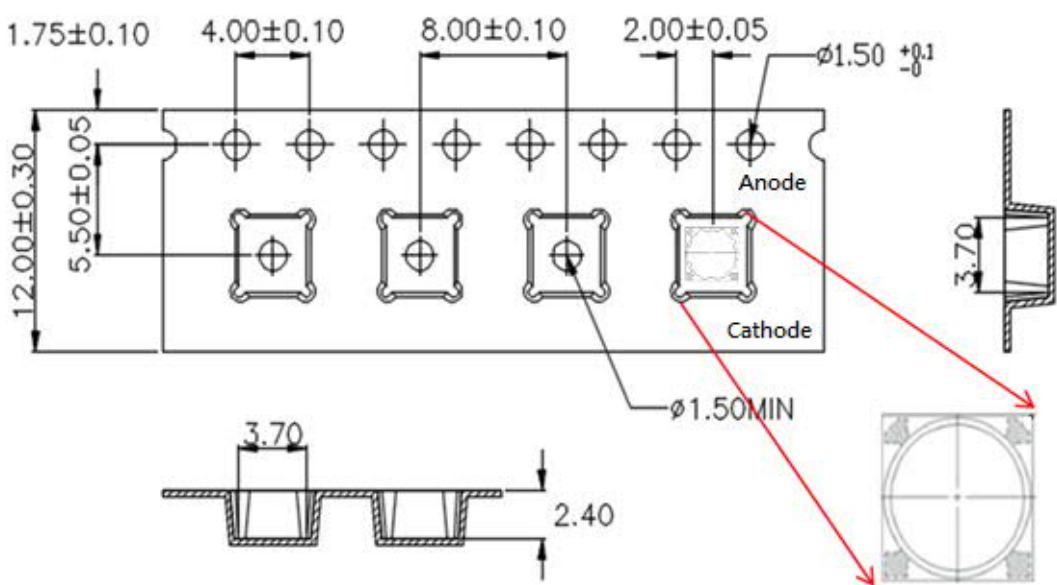
Recommend Printed Circuit Board Attachment Pad



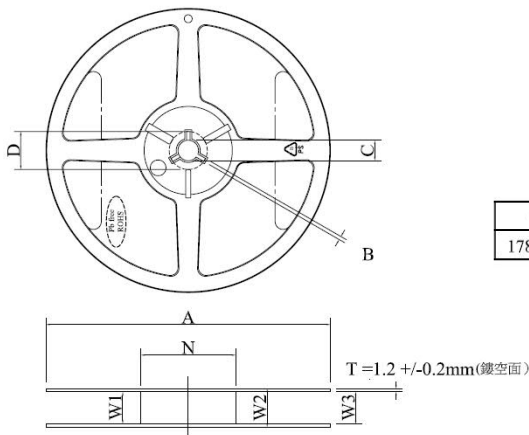
Notes:

1. The LEDs can be soldered using the reflow soldering or hand soldering method. The recommended hand soldering condition is 300°C max. and 2secs max. only once, and the operation of reflow soldering is only up to three times at maximum.
2. All temperatures refer to topside of the package, measured on the package body surface.
3. The soldering profile could be further referred to different soldering grease material characteristic. The grease vendor will provide this information.
4. A rapid-rate process is not recommended for the LEDs cooling down from the peak temperature.
5. Although the recommended reflow conditions are specified above, the reflow or hand soldering condition at the lowest possible temperature is desirable for the LEDs.
6. YesLED cannot make a guarantee on the LEDs which have been already assembled using the dip soldering method.

Package Dimensions of Tape



Package Dimensions of Reel



A	N	W1	W2	W3	D	B	C
178 ± 1.0	60 ± 1.5	$12.4 \begin{smallmatrix} +0.0 \\ -0.0 \end{smallmatrix}$	15.0 ± 1.0	> 12	21.0 ± 0.8	2.2 ± 0.5	$13.0 \begin{smallmatrix} +0.5 \\ -0.2 \end{smallmatrix}$

Notes:

1. Empty component pockets sealed with top cover tape.
2. 7 inch reel-maximum 500 pieces per reel.
- 3 The maximum number of consecutive missing lamps is two.
- 4 In accordance with EIA-481-1-B specifications.

9. Cautions

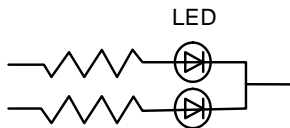
Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

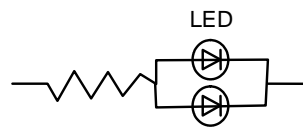
Do not use unspecified chemical liquid to clean LED, it could harm the package.

Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit below.



Circuit model A



Circuit model B

(A) Recommended circuit.

(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

© This LED should be used under forward current, particularly not used under continuous reverse current to avoid the damage to LED.

The electrode pads are plated with gold, but it is still not recommended to the use under any of the following conditions, please confirm the performance and reliability are well enough if you use it under any of the following conditions

- Do not use sulfur-containing materials in commercial products including the materials such as seals and adhesives that may contain sulfur.
- Do not put this product in a place with a lot of moisture (over 85% relative humidity), dew condensation, briny air, and corrosive gas (Cl, H₂S, NH₃, SO₂, NO_x, etc.).

Manual Handling Remark

The LED should only be picked up by making contact with the sides of the LED body. It should not put any pressure on the lens either by finger or any hand tool. Do not puncture or push the lens.

ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or “no light up” at low currents. To verify for ESD damage, check for “light up” and V_F of the suspect LEDs at low currents. The V_F of “good” LEDs should be [>2.0V@0.5mA](#).

Training and Certification

1. Working area is ESD-certified.
2. Training records and re-certification dates monitored.

Static-Safe Workstation & Work Areas

1. Static-safe working stations or work-areas have ESD signs.
2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V.
3. All ionizer activated, positioned towards the units.
4. Each work surface mats grounding is good.

Personnel Grounding

1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring.
2. If conductive footwear used, conductive flooring also present.
3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V.
4. The wrist strap or heel strap/conductive shoes are checked daily and result recorded.
5. All wrist strap or heel strap checkers calibration up to date.

Device Handling

1. Each ESDS items identified by EIA-471 labels on item or packaging..
2. No static charge generators (e.g. plastics) inside shielding containers with ESDS items.
3. All flexible conductive and dissipative package materials are inspected before reuse or recycles

Storage

This product is qualified as Moisture sensitive Level 3 per JEDEC J-STD-020 Precaution when handling this moisture sensitive product is important to ensure the reliability of the product.

The package is sealed:

The LEDs should be stored at 30°C or less and 85%RH or less. And the LEDs are limited to use within one year, while the LEDs is packed in moisture-proof package with the desiccants inside.

The package is opened:

The LEDs should be stored at 30°C or less and 60%RH or less. The LEDs are limited to solder process within 168hrs. If the Humidity Indicator shows the pink color in 10% even higher or exceed the storage limiting time since opened, we recommended to baking LEDs at 60°C at least 24hours before solder. To seal the remainder LEDs return to package, it's recommended to be with workable desiccants in original package.

Safety

Do NOT directly look at the UV light from LED or optical instrument because it is harmful to human eyes. And it is recommended to use UV goggles protective glasses for avoiding eye damage.